MASTERseries

Release 5.1

Cell Site Access Platform



Key Benefits:

- 1/0 grooming reduces link costs
- Integrated IP router for LAN interconnection
- High port density and small footprint conserve valuable space
- Environmental hardening and lightning protection enhance reliability
- Extensive test capabilities reduce operations costs

Key Applications:

- Cell Site T1 termination (CSU, DSU/CSU)
- TI IAD (voice, data, LAN interconnection)
- · Access IP router for LAN interconnection
- · Increase TI link capacity
- · TI aggregation and grooming
- ATM Access Concentrator

Consolidated, single-platform solution for delivering next generation wireless voice and data services

The MASTERseries[™] platform provides a hardened and cost-effective platform for TI network access solutions. Various combinations of enclosures, application modules, and plug-on adapters create a flexible and scalable solution to your mission-critical interconnection issues. The MASTERseries provides the capability to provide a wide range of access solutions including DSU/CSU, 32 port I/0 DCS (Digital Cross-connect Switch), cell site IAD (Integrated Access Device) with ATM (Asynchronous Transfer Mode) access and integral Ethernet router.

MASTERseries is hardened — designed for the demanding needs of mission critical applications and mobile service providers. Hardening includes self-healing lighting protection, a temperature range of -40 °C to 65 °C, optional redundant power supplies and automatic link protection switching.

MASTERseries platform with FLEXmaster Application Modules can be managed by the Carrier Access OMC-Companion element management system, or by standard intuitive web browser-based graphical user interface, Telnet or VT-100 menus.

Application Modules supported:

FLEXmaster8 TDM Module

The FLEXmaster8 TDM Module provides 8 T1 ports, 16 T1 mid-plane module-to-module cross-connect, V.35 port, integrated IP Router with 2 10/100 Ethernet ports.

FLEXmaster8 ATM Module

The FLEXmaster8 ATM Module provides 8 T1 ATM-IMA ports with IWF and CES capability, 16 T1 mid-plane module-to-module cross-connect, V.35 port and 2 10/100 Bridged Ethernet ports.

FLEXmasterDS3c-3 ATM Module

The FLEXmasterDS3c-3 Module provides 3 DS3c ATM ports, and 16 T1 mid-plane module-to-module cross-connect. The FLEXmasterDS3c-3 ATM Module supports ATM-IMA with IWF and CES capability, 16 T1 mid-plane module-to-module cross-connect, and 2 10/100 Bridged Ethernet ports.

HUBmaster Module

The HUBmaster Module provides a 5 port 10/100 Ethernet hub.



Technical Specifications for the MASTERseries Platform

Platform Features:

- Two different shelf configurations
- I Rack Unit (RU) dual slot enclosure
- 3 RU eight slot enclosure
- Integral I/O Digital Cross-connect Switch (DCS)
- · IP-based management channel concentration
- Support for up to 32 full or fractional T1 links
- Web based GUI, Telnet and Menu support
- Environmentally hardened (-40 °C to 65 °C) with selfhealing lightning protection
- · Hot swappable application modules and power modules
- Wide Range 24/-48 VDC power
- · Optional power redundancy

Capacities:

- 2 Slot Enclosure
 - 2 Power Modules
 - 2 Interface Adapters
- Up to 2 FLEXmaster Application Modules
- 8 Slot Enclosure
 - 2 Power Modules
 - 8 universal Application Modules
 - Up to 4 FLEXmaster Application Modules must be installed where there are open slots on either side of the module to conform to environmental specifications (example: FLEXmaster Modules in slot #1, 3, 5, and 7 if fully populating the 8 slot enclosure)

- Loopback Types: Bi-directional, Fractional DS0/E0, Line, Local, Payload, Equipment, Dataport (local or remote), Remote in-band/out-of-band, fixed or timed options
- BERT: All ones, all zeros, alternating, 2²⁴⁻¹

Performance Monitoring:

- Data Storage: Last 24 hours of data in 15 minute increments, 48 and 72 hour summaries
- Monitors: All network interfaces
- Reports: Based on T1.403

Service Modules Supported:

- FLEXmaster8 TDM Application Module (see individual specification sheet for more information)
- FLEXmaster8 ATM Application Module (see individual specification sheet for more information)
- FLEXmasterDS3c-3 ATM Application Module (see individual specification sheet for more information)

TI Interfaces (FLEXmaster8):

- Line Rate: 1.544 Mb/s (T1)
- Framing: SF/ESF per TR54016/TR62411
- Interface: AMI or B8ZS
- Connector: Female 8 pin RJ-48C
- Timing: Internal or External from any network port
- LED Indicators: YEL/TEST, OOF/LOS, SYNC, AIS, MINOR
- · Signaling: Clear channel, bundled or robbed bit

Data Interfaces:

- Date Rate: N x 56/64 kb/s, N=1-24
- Interface: DCE Synchronous CCITT V.35
- Connector: Female 25-pin DB connector
- LED Indicators: RxD, TxD

DS3c Interfaces (FLEXmasterDS3c-3):

- · Rear Access SMA DS3 connectors
- Compliant with ATM Forum DS3 Physical Layer Interface af-phy-0054.000
- Line build out: Short: 0-50 ft., Normal: 50-450 ft.
- Line rate: 44.736 Mbps
- Line code: B3ZS
- · Framing format: M23 and C-bit parity
- Transmit Impedance: 75. ± 5% resistive, unbalanced
- Transmit Jitter Attenuation: Meets ANSI T1.102

- Transmit Amplitude: Meets ANSIT1.102 pulse mask with 0.36 to 0.85 Vp
- Transmit Length (cable) 500 ft. to cross-connect
- Receive Sensitivity: -10 dB w/r DSX-3 120 mVp to 900 mVp input range with automatic gain control circuit

IP Routing:

- Dual Ethernet Interfaces: 10/100Mb per IEEE 802.3
- LAN Protocols:TCP/IP
- WAN Protocols: PPP, Frame Relay (RFC 1490)
- DHCP: Server, relay agent, and client
- RIP, RIPv2, static routing, OSPF vI
- Supports un-numbered IP interface
- Security: PAP, CHAP, NAT/NAPT, rules-based firewall
- Ping, Trace Route

- External Alarm : Form "C" relay contact closure
- Major/Minor

Management:

- Managed network element under OMC-Companion
- Remote Access: In band via DS0, Telnet supported
- VT100: RS232 port, 4800-19,200 bps;
- RJ-45 connector, external modem supported
- Password control: three levels of access
- Web browser-based GUI

VDC: 2 slot and 8 slot: +/- 20 to 65 VDC

Regulatory Approvals:

- USA
 - UL60950-I
 - FCC Part 15, Class A
 - FCC Part 68 and TIA-968-A
- Canada
 - CSA 60950-I
 - ICES-003 Class A
 - CS-03

Physical:

- 2 Slot Enclosure
 - Dimensions:
 - 1.75 in (1 RU)(H) x 19 in (W) x 10.2 in (D)
 - 44 cm (2 RU)(H) 483 cm (W) 259 cm (D)
- Weight: 19 lb (8.62 kg) fully loaded
- Rack mount: 19-inch
- 8 Slot Enclosure
 - Dimensions:
 - 5.25 in (3 RU)(H) x 19 in (W) x 10.2 in (D)
 - · 133 cm (2 RÚ)(H) 483 cm (W) 259 cm (D)
 - Weight: 30 lb (13.61 kg) fully loaded
 - Rack mount: 19-inch

Environment:

- Operating temperature range: -40 °F to 149 °F (-40 °C to
- Storage temperature range: -40 °F to 158 °F (-40 °C to 70 °C)
- Cooling method is by free air convection (rack mounting requires .5 RU minimum above and below each unit)
- Maximum operating altitude: 10,000 ft (3,048 m)
- Minimum operating altitude: 197 ft (60 m) below sea level
- Maximum non-operating altitude: 40,000 ft (12,192 m) Relative humidity (non-condensing) range: 0% to 95%

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